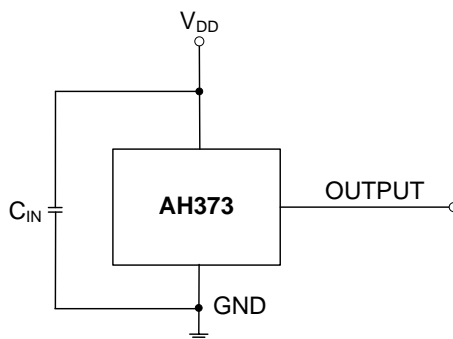


Typical Application Circuits (Cont.)



Typical AH373 Circuit

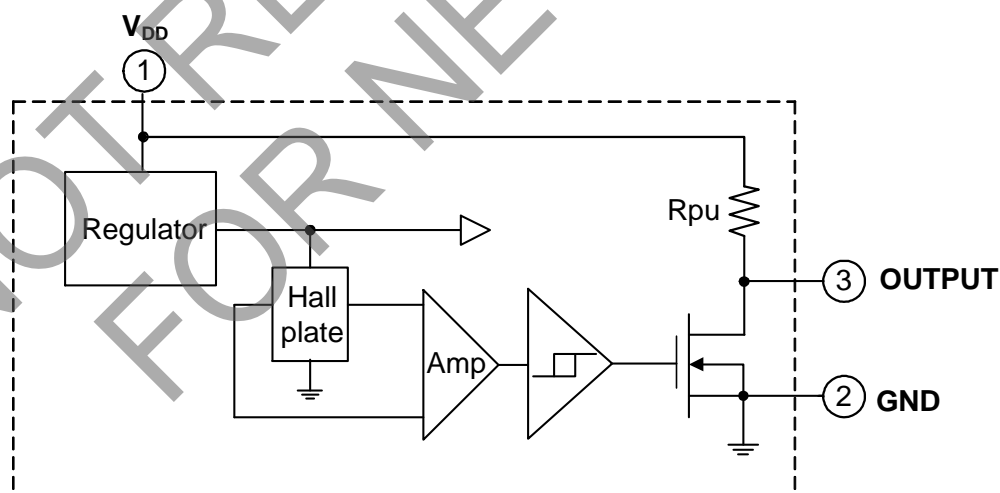
Note: 4. C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 100nF typical.

Pin Descriptions

Packages: SC59, SOT23 and SIP-3

Pin Number	Pin Name	Function
1	V _{DD}	Power Supply Input
2	GND	Ground
3	OUTPUT	Output

Functional Block Diagram



Absolute Maximum Ratings (Note 5) @T_A = +25°C, unless otherwise specified.)

Symbol	Characteristics		Value	Unit
V _{DD}	Supply Voltage (Note 6)		28	V
V _{OUT} (Off)	Output "Off" Voltage		28	V
I _O (Sink)	Output "On" Current (Sink)		25	mA
B	Magnetic Flux Density		Unlimited	
P _D	Package Power Dissipation	SIP-3	550	mW
		SC59 and SOT23	230	mW
T _S	Storage Temperature Range		-65 to +150	°C
T _J	Maximum Junction Temperature		+150	°C

Notes: 5. Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.

6. The absolute maximum V_{DD} of 28V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

Recommended Operating Conditions (@T_A = +25°C, unless otherwise specified.)

Symbol	Characteristic	Conditions	Rating	Unit
V _{DD}	Supply Voltage (Note 7)	Operating	2.2 to 20	V
T _A	Operating Temperature Range	Operating	-40 to +125	°C

Note: 7. The output of IC will be switched after the supply voltage is over 2.2V, but the magnetic characteristics will not be normal until the supply is over 2.5V.

Electrical Characteristics (@T_A = +25°C, V_{DD} = 12V, unless otherwise specified.)

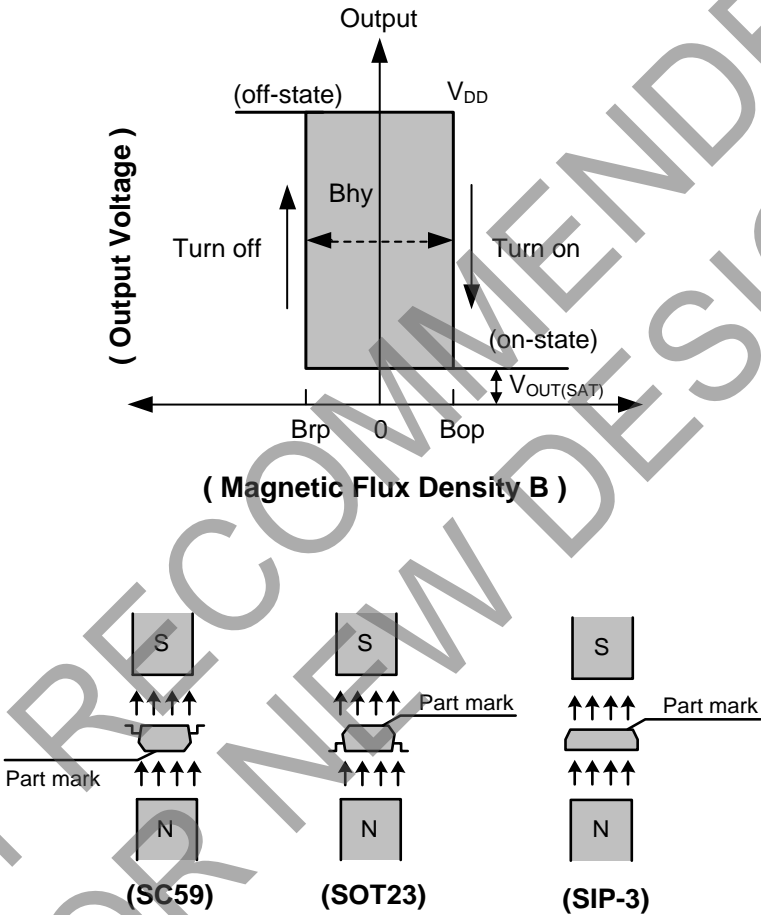
Symbol	Characteristic	Conditions	Min	Typ	Max	Unit
V _{OUT}	Output On Voltage	I _{OUT} = 20mA	—	300	400	mV
I _{DD}	Supply Current	B < Brp	—	2	4	mA
I _{OFF}	Output Leakage Current	Output off	—	< 0.1	10	μA
R _{pu}	Internal Pull-up Resistor	—	7	10	13	kΩ

Magnetic Characteristics (Note 8) (@T_A = +25°C, V_{DD} = 2.5V to 20V, unless otherwise specified.)

(1mT=10 Gauss)

Symbol	Characteristic	Min	Typ	Max	Unit
Bop (South pole to part marking side for SIP-3 and SOT23; North pole to part marking side for SC59)	Operation Point	5	30	60	Gauss
Brp (South pole to part marking side for SIP-3 and SOT23; North pole to part marking side for SC59)	Release Point	-60	-30	-5	
Bhy (Bopx - Brpx)	Hysteresis	—	60	—	

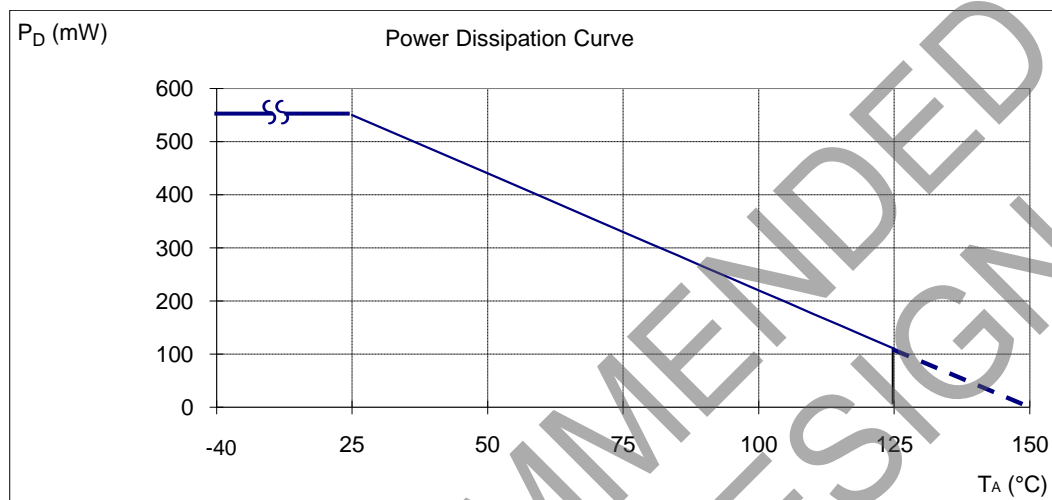
Note: 8. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.



Thermal Performance Characteristics

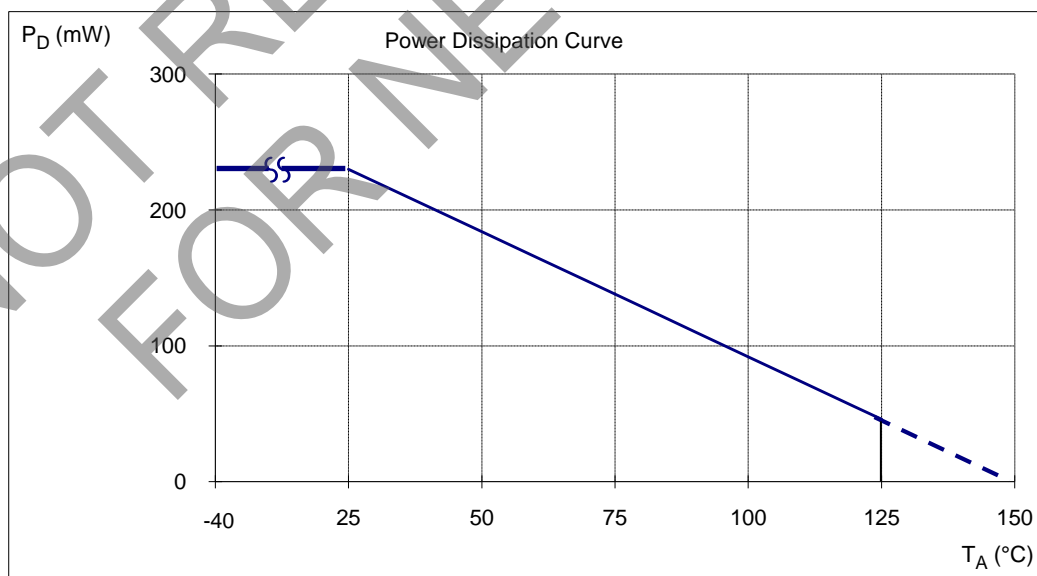
(1) Package Type: SIP-3

T _A (°C)	25	50	60	70	80	85	90	95	100	105	110	115	120	125	130	135	140	150
P _D (mW)	550	440	396	352	308	286	264	242	220	198	176	154	132	110	88	66	44	0

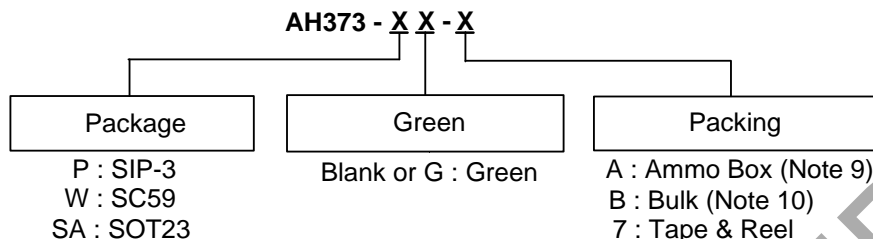


(2) Package Type: SC59 and SOT23

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	230	184	166	147	129	120	110	92	83	74	55	46	37	18	0



Ordering Information



Part Number	Status (Note 11)	Package Code	Packaging (Note 12)	Bulk		7" Tape and Reel		Ammo Box	
				Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH373-PG-A	NRND	P	SIP-3	NA	NA	NA	NA	4000/Box	-A
AH373-PG-B	NRND	P	SIP-3	1000	-B	NA	NA	NA	NA
AH373-WG-7	NRND	W	SC59	NA	NA	3000/Tape & Reel	-7	NA	NA
AH373-SA-7	NRND	SA	SOT23	NA	NA	3000/Tape & Reel	-7	NA	NA

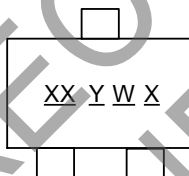
Notes:

9. Ammo Box is for SIP-3 Spread Lead.
10. Bulk is for SIP-3 Straight Lead.
11. NRND = Not Recommended for New Design
12. Pad layout as shown on Diodes Incorporated's suggested pad layout document, which can be found on our website at <http://www.diodes.com/package-outlines.html>.

Marking Information

(1) Package Types: SC59 and SOT23

(Top View)

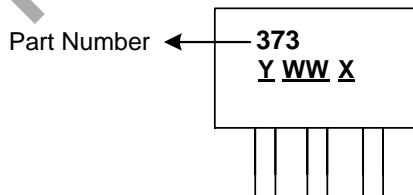


XX : Identification code
Y : Year 0 to 9
W : Week : A to Z : 1 to 26 week;
a to z : 27 to 52 week; z represents 52 and 53 week
X : Internal Code: A ~ Z : Green
a ~ z : Lead Free

Part Number	Package	Identification Code
AH373	SC59	P2
AH373	SOT23	S2

(2) Package Type: SIP-3

(Top View)



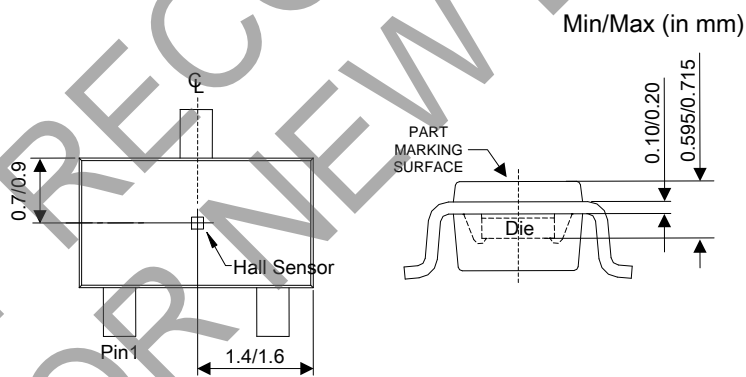
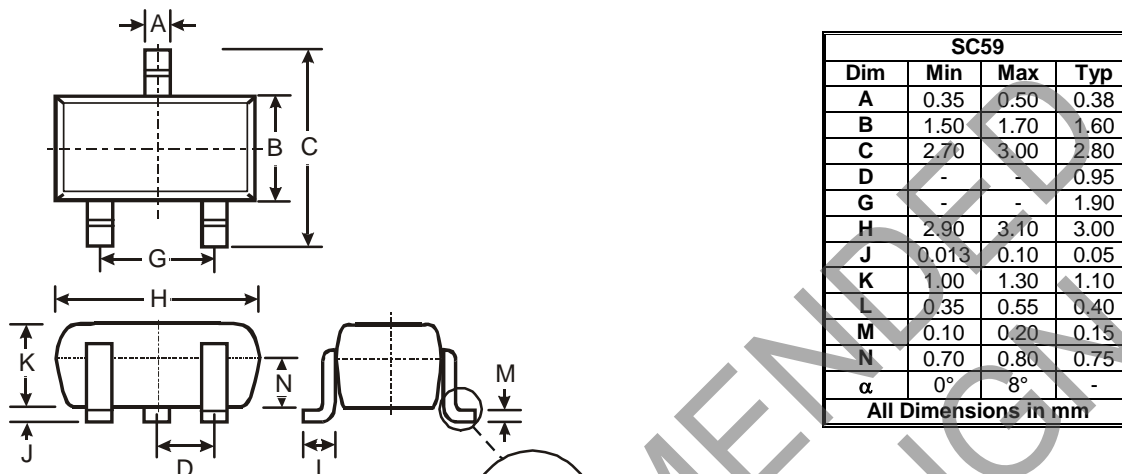
Y : Year : 0~9
WW : Week : 01~52, "52" represents 52 and 53 week
X : Internal Code: A ~ Z : Green
a ~ z : Lead Free

Part Number	Package	Identification Code
AH373	SIP-3 (Ammo Pack)	373
AH373	SIP-3 (Bulk Pack)	373

Package Outline Dimensions (All dimensions in mm.)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(1) Package Type: SC59

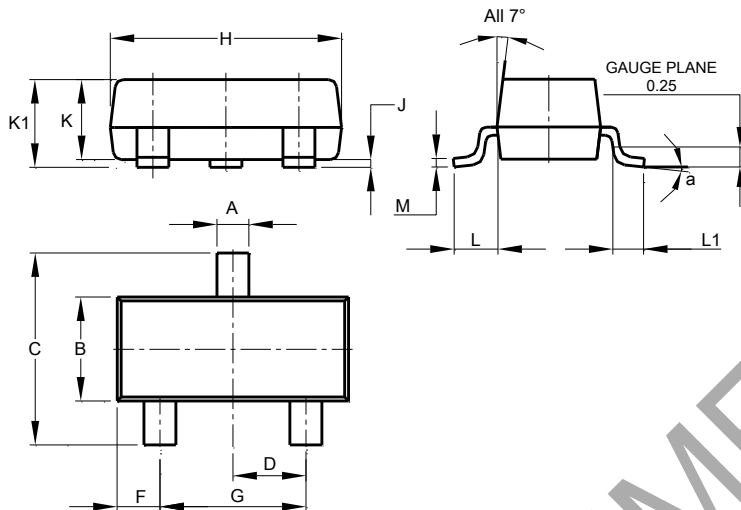


Sensor Location

Package Outline Dimensions (Cont.) (All dimensions in mm.)

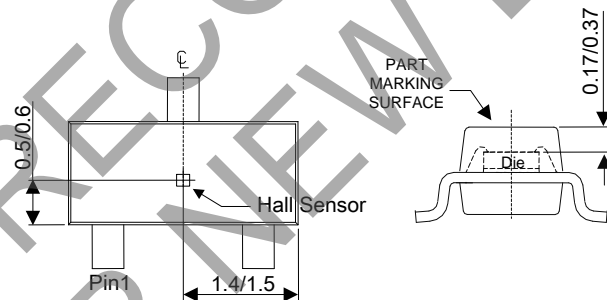
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(2) Package Type: SOT23



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

Min/Max (in mm)

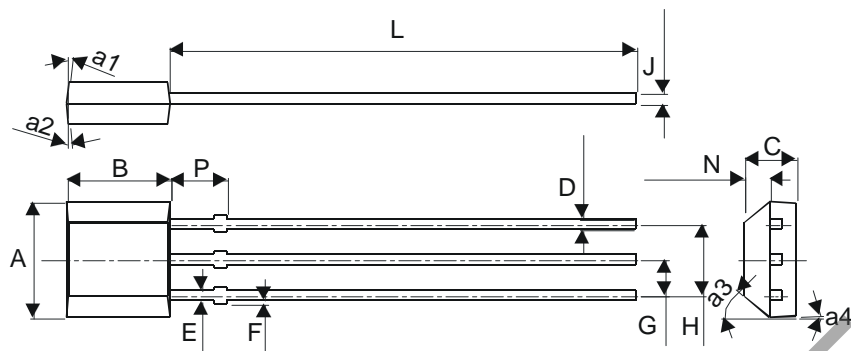


Sensor Location

Package Outline Dimensions (Cont.) (All dimensions in mm.)

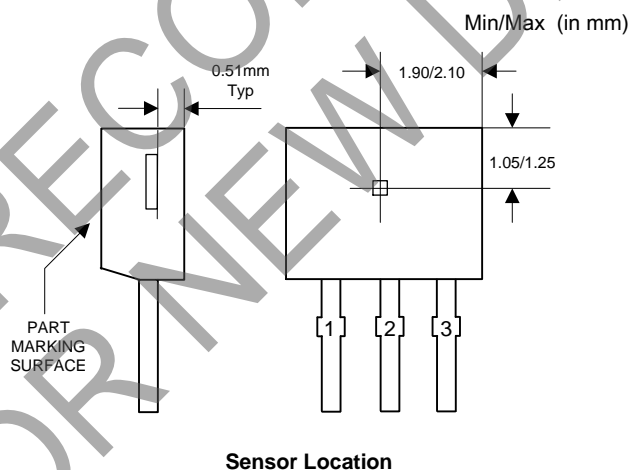
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(3) Package Type: SIP-3 (Bulk Pack)



SIP-3 (Bulk Pack)		
Dim	Min	Max
A	3.9	4.3
a1	5° Typ	
a2	5° Typ	
a3	45° Typ	
a4	3° Typ	
B	2.8	3.2
C	1.40	1.60
D	0.33	0.432
E	0.40	0.508
F	0	0.2
G	1.24	1.30
H	2.51	2.57
J	0.35	0.43
L	14.0	15.0
N	0.63	0.84
P	1.55	-
All Dimensions in mm		

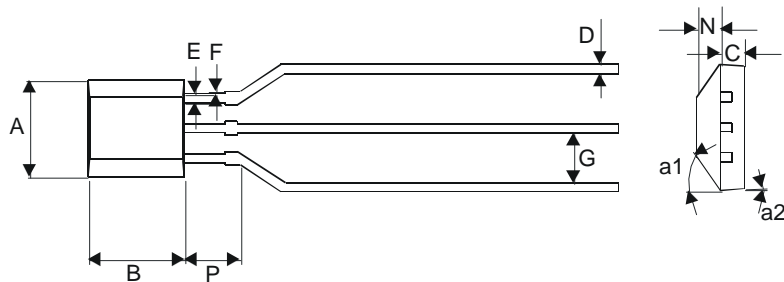
Notes: 12. SIP-3 (Bulk Pack) - Thickness J includes Burrs



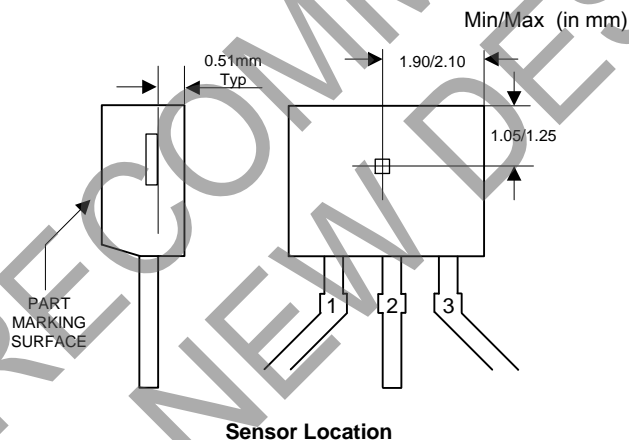
Package Outline Dimensions (Cont.) (All dimensions in mm.)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(4) Package Type: SIP-3 (Ammo Pack)



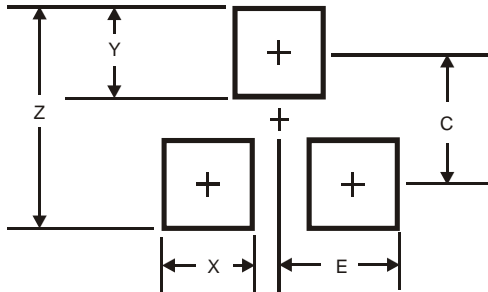
SIP-3 (Ammo Pack)		
Dim	Min	Max
A	3.9	4.3
a1	45° Typ	
a2	3° Typ	
B	2.8	3.2
C	1.40	1.60
D	0.35	0.41
E	0.43	0.48
F	0	0.2
G	2.4	2.9
N	0.63	0.84
P	1.55	-
All Dimensions in mm		



Suggested Pad Layout

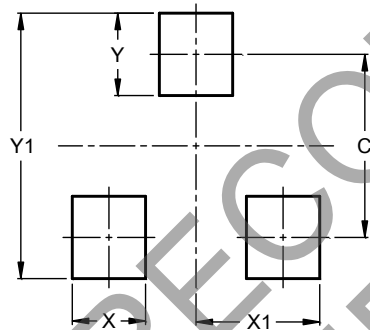
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(1) Package Type: SC59



Dimensions	Value (in mm)
Z	3.4
X	0.8
Y	1.0
C	2.4
E	1.35

(2) Package Type: SOT23



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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